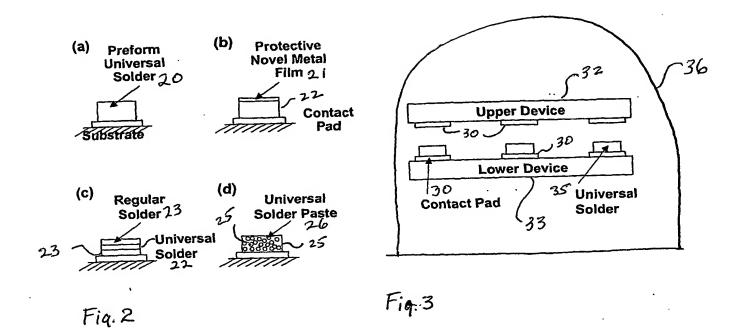
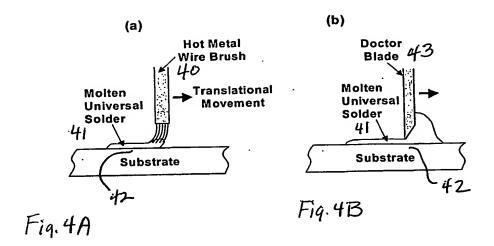
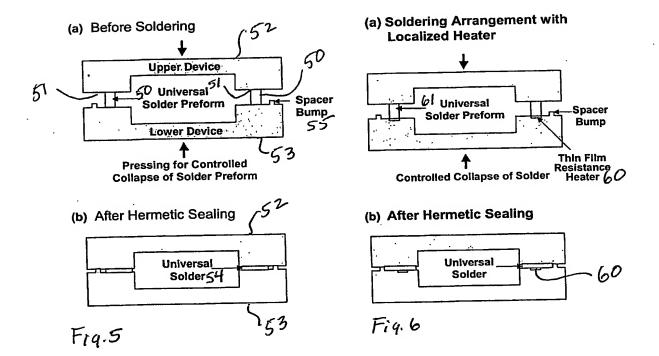
- the same of the	
Provide articles having bonding surfaces	NA
bonding surfaces	
	
Dispose universal solder	
or braze between	NB
bonding surfaces	
	·
Wet the surfaces with	
solder and bond, under	NC
substantially oxygen-free	
conditions.	
	ļ

Fiq. 1







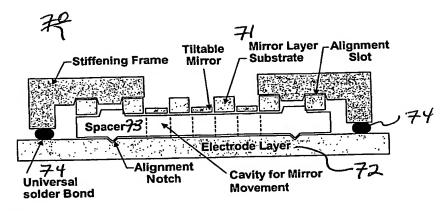
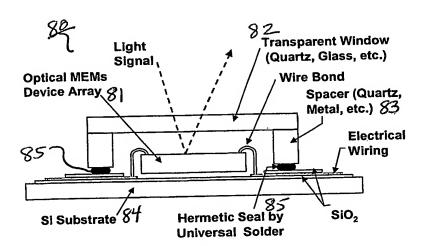
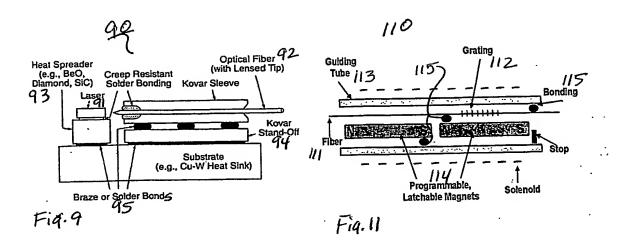


Fig. 7



Fiq. 8



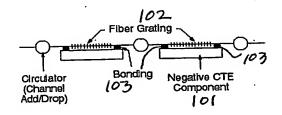


Fig. 10